TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

S S M 3 K 0 9 F U

High Speed Switching Applications

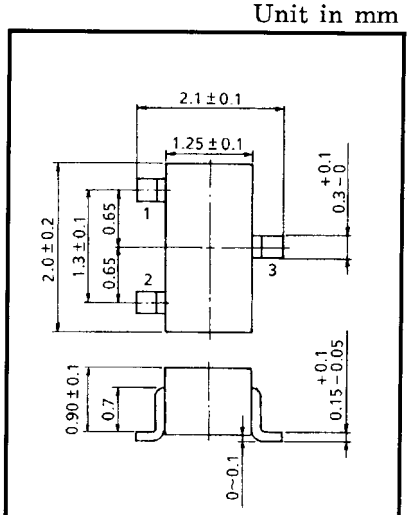
- Small package
- Low on resistance
  : R_{on} = 0.7 Ω (max) (@V_{GS} = 10 V)
  : R_{on} = 1.2 Ω (max) (@V_{GS} = 4 V)

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V_{DS}	30	V
Gate-Source voltage		V_{GSS}	±20	V
Drain current	DC	I_D	400	mA
	Pulse	I_{DP}	800	
Drain power dissipation (Ta = 25°C)		P_D (Note1)	150	mW
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	−55~150	°C

Note1: Mounted on FR4 board
(25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6 mm^2 × 3) Figure 1.

Unit in mm

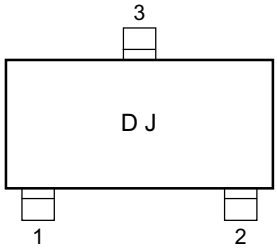


1 : GATE
2 : SOURCE
3 : DRAIN

USM	
JEDEC	—
EIAJ	SC-70
TOSHIBA	2-2E1E

Weight : 0.006 g (Typ.)

Marking



Equivalent Circuit (top view)

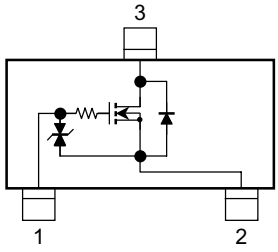
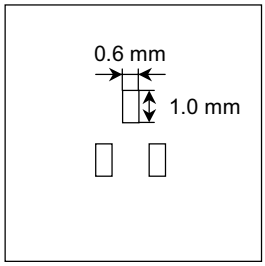


Figure 1: 25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6 mm^2 × 3



Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

000707EAA2

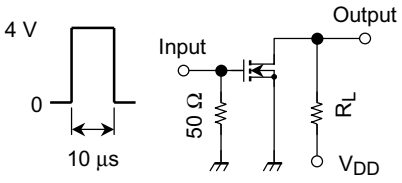
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±16 V, V_{DS} = 0	—	—	±1	μA
Drain-Source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 1 mA, V_{GS} = 0	30	—	—	V
Drain cut-off current		I_{DSS}	V_{DS} = 30 V, V_{GS} = 0	—	—	1	μA
Gate threshold voltage		V_{th}	V_{DS} = 5 V, I_D = 0.1 mA	1.1	—	1.8	V
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 5 V, I_D = 200 mA (Note2)	270	—	—	mS
Drain-Source ON resistance		$R_{DS\ (ON)}$	I_D = 200 mA, V_{GS} = 10 V (Note2)	—	0.5	0.7	Ω
			I_D = 200 mA, V_{GS} = 4 V (Note2)	—	0.8	1.2	
			I_D = 200 mA, V_{GS} = 3.3 V (Note2)	—	1.0	1.7	
Input capacitance		C_{iss}	V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz	—	20	—	pF
Reverse transfer capacitance		C_{rss}	V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz	—	7	—	pF
Output capacitance		C_{oss}	V_{DS} = 5 V, V_{GS} = 0, f = 1 MHz	—	16	—	pF
Switching time	Turn-on time	t_{on}	V_{DD} = 5 V, I_D = 200 mA,	—	72	—	ns
	Turn-off time	t_{off}	V_{GS} = 0~4 V	—	68	—	ns

Note2: Pulse test

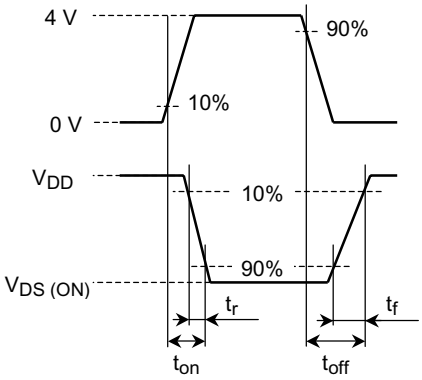
Switching Time Test Circuit

(a) Test circuit



V_{DD} = 5 V
D.U. ≦ 1%
Input: t_r, t_f < 5 ns
(Z_{out} = 50 Ω)
Common Source
Ta = 25°C

(b) V_{IN}



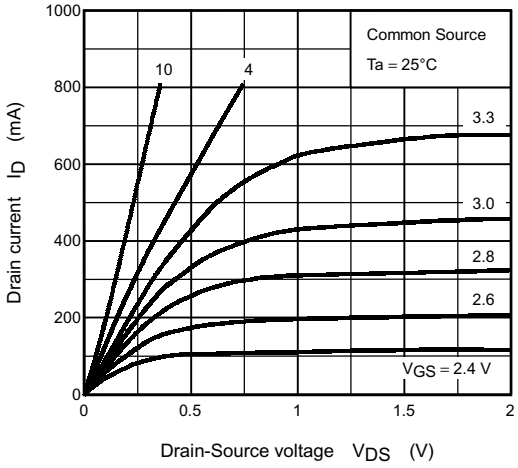
(c) V_{OUT}

Precaution

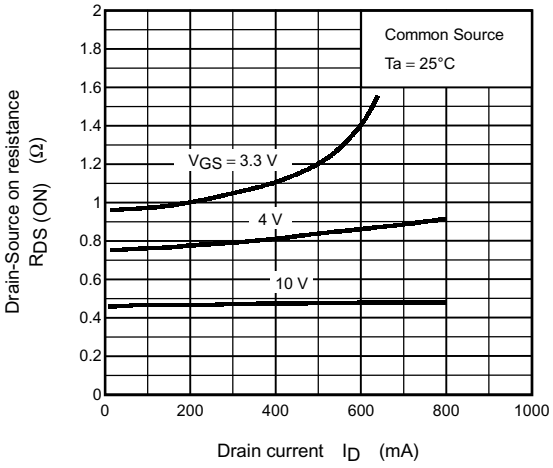
V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = 100 μA for this product. For normal switching operation, $V_{GS\ (on)}$ requires higher voltage than V_{th} and $V_{GS\ (off)}$ requires lower voltage than V_{th}.
(relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$)

Please take this into consideration for using the device.
V_{GS} recommended voltage of 4.0 V or higher to turn on this product.

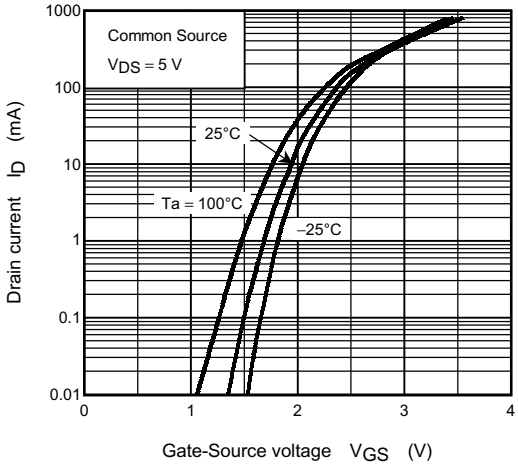
$I_D - V_{DS}$



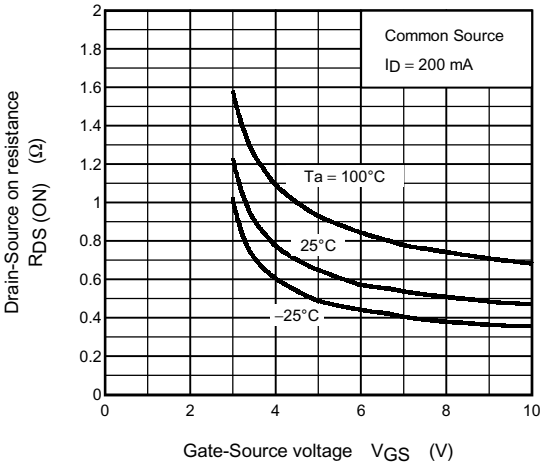
$R_{DS\ (ON)} - I_D$



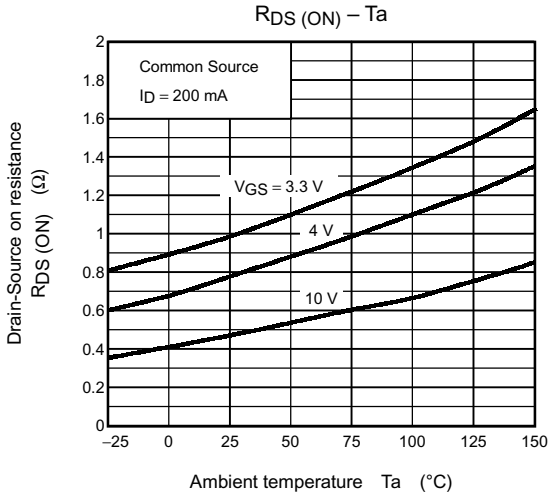
$I_D - V_{GS}$



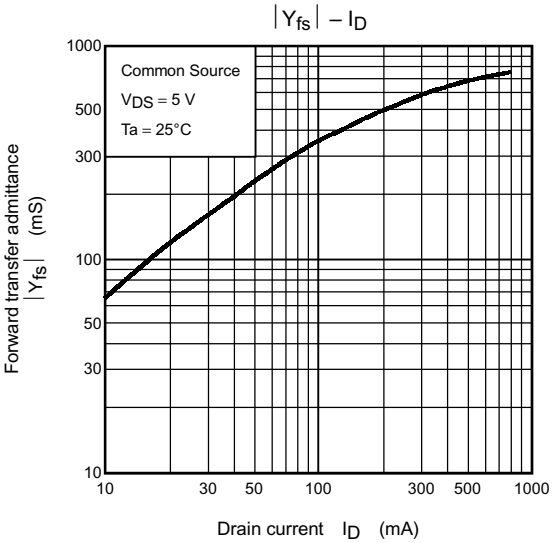
$R_{DS\ (ON)} - V_{GS}$



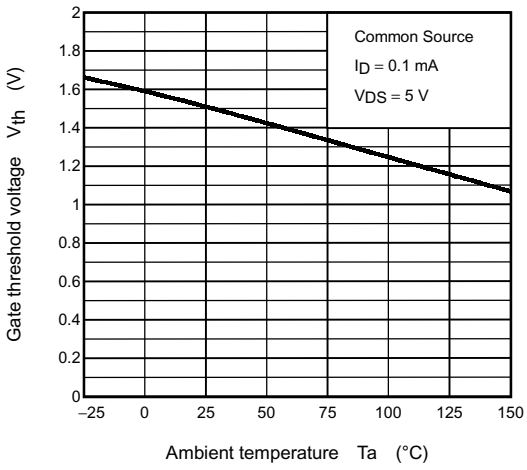
$R_{DS\ (ON)} - Ta$



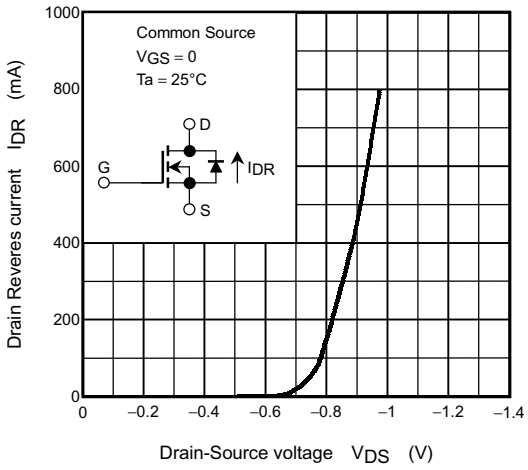
$|Y_{fs}| - I_D$



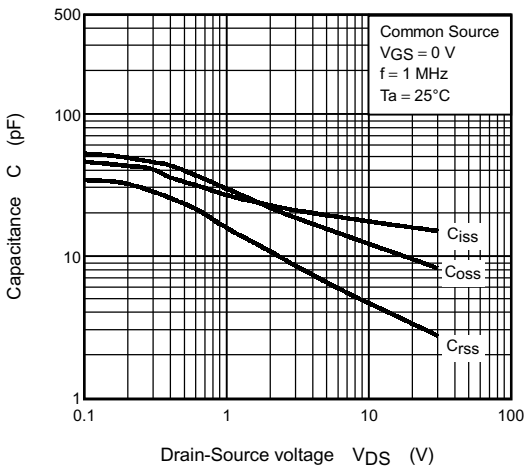
V_{th} – Ta



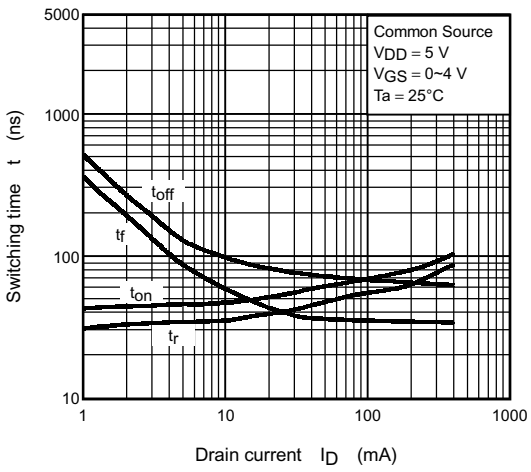
I_{DR} – V_{DS}



C – V_{DS}



t – I_D



P_D – Ta